ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES®	C. Bannock	burn, Illinois, A	ll rights reserved nations.	under both	This docume level parts, t	ent is a declaration entite decl	on of the su compasses	bstances v all lower	vithin the manufactu level materials for w	rer listed i which the r	tem. Note: nanufacture	if the item is an as r has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					tion				
upplier Information														
Company name*			Company unique ID			Unique ID Authority				Respon	Response Date*			
nsemi										2023-06-08				
tact Name Title - Contact					Phone - Contact*				Email - Contact*					
Product-Env-Stewards Product Enviro Comp			ro Compliance	Compliance		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			sentative	P		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product			oduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		nber Mfr Item Name			Effective Date	Version	М	lanufacturing Site		Weight*	UOM	Unit Type	
	LC7032 H	C703200AW-8C99- Portable Sound De		Device	2023-			PI	РНМ		400.0	mg	Each	
Aanufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Mat	terial	al Terminal Base Alloy		J-STD-020 MSI	ISL Rating Peal		ak Process Body Temperature Max Time at Peal		Tempera	ture Num	ber of Reflow Cyc	les		
contains Bi CU Alloy		CU Alloy	3			260 C 30		30	seconds 3					
omments														
TTENTION: MSL 3 Rated item requires	Bake and I	Dry Pack (after	electrical test)											
or more information regarding material of	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	10.95	mg	Supplier	Silicon (Si)	7440-21-3		10.8471	mg
			Supplier	Polyimide	Proprietary Data		0.1029	mg
Die Attach	2.36	mg	Supplier	Silver (Ag)	7440-22-4		1.6402	mg
			Supplier	Epoxy resins	129915-35-1		0.708	mg
			Supplier	Acrylic resins	Proprietary Data		0.0118	mg
Lead Frame	237.42	mg	Supplier	Silver (Ag)	7440-22-4		1.2821	mg
			Supplier	Zinc (Zn)	7440-66-6		0.4511	mg
			Supplier	Iron (Fe)	7439-89-6		6.1254	mg
			Supplier	Copper (Cu)	7440-50-8		229.229	mg
			Supplier	Phosphorus (P)	7723-14-0		0.3324	mg
Mold Compound-Black	143.55	mg		Epoxy Phenol Resin	proprietary data		20.097	mg
			Supplier	Carbon Black (C)	1333-86-4		0.7178	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		122.0175	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.7178	mg
Plating	4.2	mg	В	Bismuth (Bi)	7440-69-9		0.0252	mg
			Supplier	Tin (Sn)	7440-31-5		4.1748	mg
Wire Bond - Au	1.52	mg	Supplier	Gold (Au)	7440-57-5		1.52	mg